



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
INPUT					
Reverse voltage			V _R	6	V
Forward current			I _F	60	mA
Surge current			I _{FSM}	2.5	A
Derate from 25 °C				1.33	mW/°C
OUTPUT					
Peak off-state voltage		VO4157D/H/M	V _{DRM}	700	V
		VO4158D/H/M	V _{DRM}	800	V
RMS on-state current			I _{TM}	300	mA
Derate from 25 °C				6.6	mW/°C
COUPLER					
Isolation test voltage (between emitter and detector, climate per DIN 500414, part 2, Nov. 74)	t = 1 min		V _{ISO}	5300	V _{RMS}
Storage temperature range			T _{stg}	- 55 to + 150	°C
Ambient temperature range			T _{amb}	- 55 to + 100	°C
Soldering temperature	max. ≤ 10 s dip soldering ≥ 0.5 mm from case bottom		T _{sld}	260	°C

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability. This phototriac should not be used to drive a load directly. It is intended to be a trigger device only.



Fig. 1 - Recommended Operating Condition

THERMAL CHARACTERISTICS			
PARAMETER	SYMBOL	VALUE	UNIT
LED power dissipation	P_{diss}	100	mW
Output power dissipation	P_{diss}	500	mW
Total power dissipation	P_{tot}	600	mW
Maximum LED junction temperature	$T_{jmax.}$	125	°C
Maximum output die junction temperature	$T_{jmax.}$	125	°C
Thermal resistance, junction emitter to board	θ_{JEB}	150	°C/W
Thermal resistance, junction emitter to case	θ_{JEC}	139	°C/W
Thermal resistance, junction detector to board	θ_{JDB}	78	°C/W
Thermal resistance, junction detector to case	θ_{JDC}	103	°C/W
Thermal resistance, junction emitter to junction detector	θ_{JED}	496	°C/W
Thermal resistance, case to ambient	θ_{CA}	3563	°C/W


Note

- The thermal characteristics table above were measured at 25 °C and the thermal model is represented in the thermal network below. Each resistance value given in this model can be used to calculate the temperatures at each node for a given operating condition. The thermal resistance from board to ambient will be dependent on the type of PCB, layout and thickness of copper traces. For a detailed explanation of the thermal model, please reference Vishay's Thermal Characteristics of Optocouplers application note.

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ °C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	$I_F = 10\text{ mA}$		V_F		1.2	1.4	V
Reverse current	$V_R = 6\text{ V}$		I_R		0.1	10	μA
Input capacitance	$V_F = 0\text{ V}$, $f = 1\text{ MHz}$		C_i		25		pF
OUTPUT							
Repetitive peak off-state voltage	$I_{DRM} = 100\text{ }\mu\text{A}$	VO4157D/H/M	V_{DRM}	700			V
		VO4158D/H/M	V_{DRM}	800			V
Off-state current	$V_D = V_{DRM}$, $I_F = 0$		I_{DRM}			100	μA
On-state voltage	$I_T = 300\text{ mA}$		V_{TM}			3	V
On-state current	$PF = 1$, $V_{T(RMS)} = 1.7\text{ V}$		I_{TM}			300	mA
Off-state current in inhibit state	$I_F = 2\text{ mA}$, V_{DRM}		I_{DINH}			200	μA
Holding current			I_H			500	μA
Zero cross inhibit voltage	$I_F = \text{rated } I_{FT}$		V_{IH}			20	V
Critical rate of rise of off-state voltage	$V_D = 0.67 V_{DRM}$, $T_J = 25\text{ °C}$		dV/dt_{cr}	5000			V/ μs
COUPLER							
LED trigger current, current required to latch output	$V_D = 3\text{ V}$	VO4157D	I_{FT}			1.6	mA
		VO4157H	I_{FT}			2	mA
		VO4157M	I_{FT}			3	mA
		VO4158D	I_{FT}			1.6	mA
		VO4158H	I_{FT}			2	mA
		VO4158M	I_{FT}			3	mA
Common mode coupling capacitance			C_{CM}		0.01		pF
Capacitance (input to output)	$f = 1\text{ MHz}$, $V_{IO} = 0\text{ V}$		C_{IO}		0.8		pF

Note

- Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

SAFETY AND INSULATION RATINGS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Climatic classification (according to IEC68 part 1)				55/100/21		
Pollution degree (DIN VDE 0109)				2		
Comparative tracking index per DIN IEC112/VDE 0303 part 1, group IIIa per DIN VDE 6110 175 399			175		399	
V_{IOTM}		V_{IOTM}	8000			V
V_{IORM}		V_{IORM}	890			V
P_{SO}		P_{SO}			500	mW
I_{SI}		I_{SI}			250	mA
T_{SI}		T_{SI}			175	°C
Creepage distance			7			mm

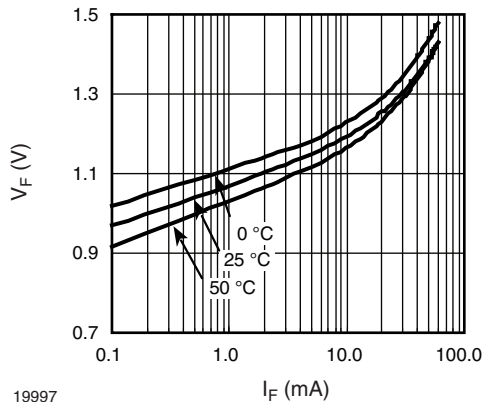
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ °C}$, unless otherwise specified)


Fig. 2 - Diode Forward Voltage vs. Forward Current



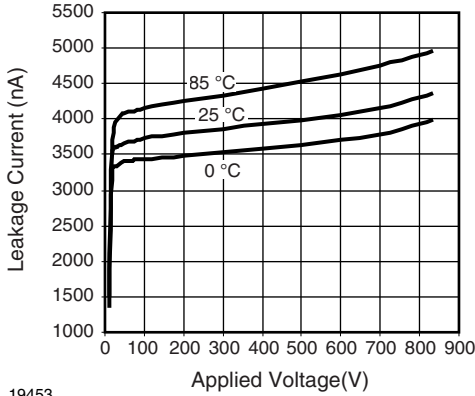
Fig. 4 - Leakage Current vs. Ambient Temperature



Fig. 3 - Diode Reverse Voltage vs. Temperature

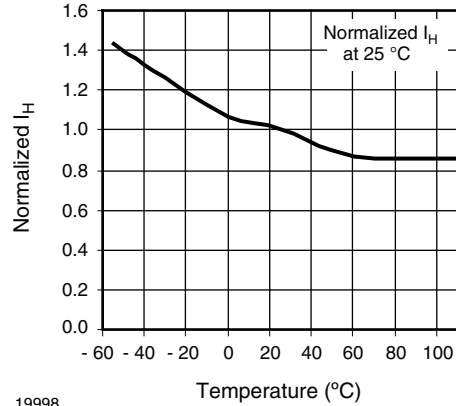


Fig. 5 - On State Current vs. On State Voltage



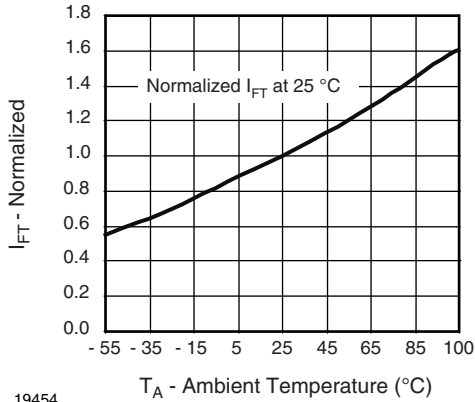
19453

Fig. 6 - Output Off Current (Leakage) vs. Voltage



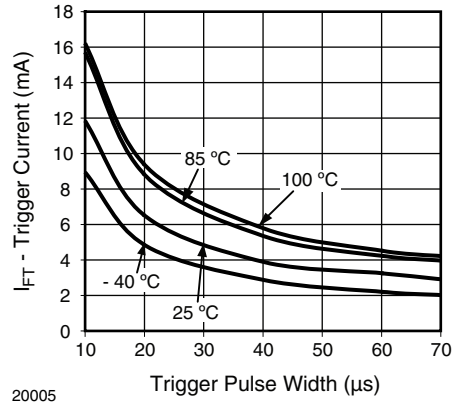
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Fig. 9 - Normalized Holding Current vs. Temperature



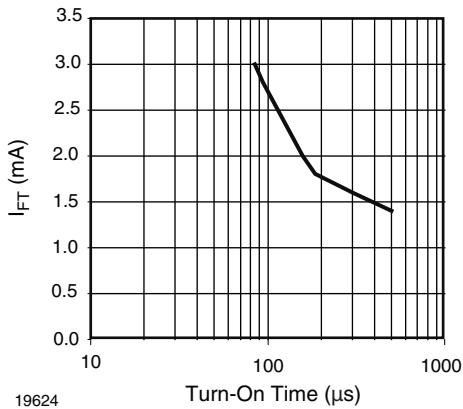
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Fig. 7 - Normalized Trigger Input Current vs. Temperature



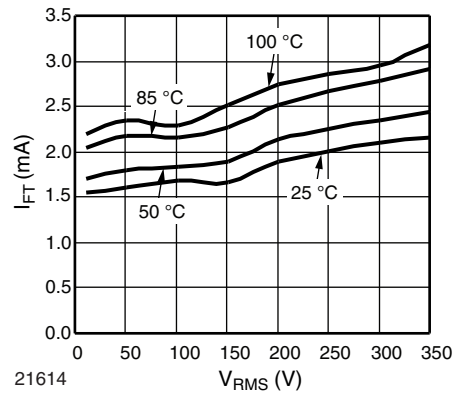
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Fig. 10 - I_{FT} vs. LED Pulse Width



19624

Fig. 8 - Trigger Current vs. Turn-On Time



21614

Fig. 11 - I_{FT} vs. V_{RMS} and Temperature

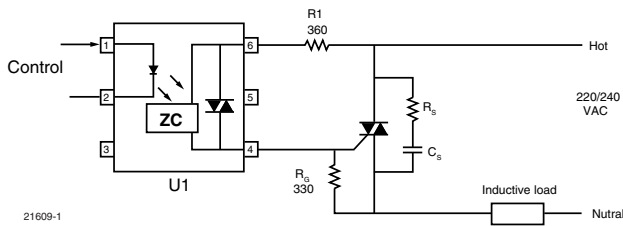


Fig. 12 - Basic Power Triac Driver Circuit

POWER FACTOR CONSIDERATIONS

As a zero voltage crossing optotriac, the commutating dV/dt spikes can inhibit one half of the TRIAC from turning on. If the spike potential exceeds the inhibit voltage of the zero-cross detection circuit, half of the TRIAC will be held-off and not turn-on. This hold-off condition can be eliminated by using a capacitor or RC snubber placed directly across the power triac as shown in fig. 11. Note that the value of the capacitor increases as a function of the load current.

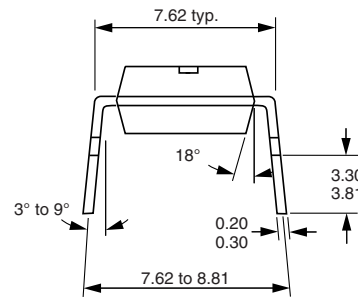
The hold-off condition also can be eliminated by providing a higher level of LED drive current. The higher LED drive current provides a larger photocurrent which causes the phototransistor to turn-on before the commutating spike has activated the zero-cross detection circuit. For example, if a device requires 1.5 mA for a resistive load, then 2.7 mA (1.8 times) may be required to control an inductive load whose power factor is less than 0.3.

PACKAGE DIMENSIONS in millimeters



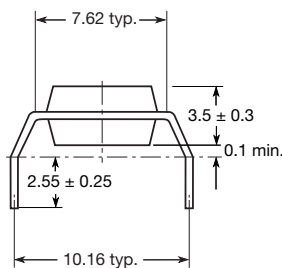
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Option 6

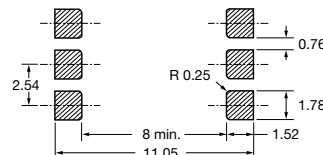
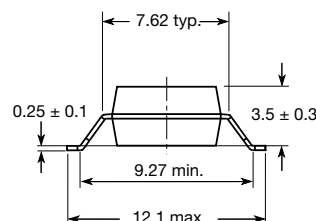
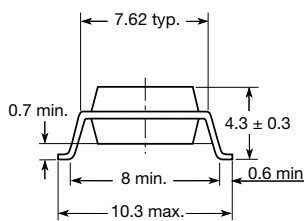


Option 7

Option 8



20802-41





PACKAGE MARKING (example)



Notes

- VDE logo is only marked on option 1 parts. Tape and reel suffix (T) is not part of the package marking.



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